# **Multilayer Ceramic Chip Capacitors** (High Capacitance)

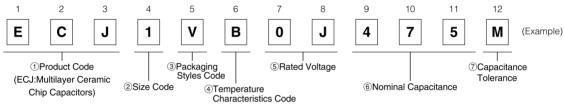
Series: **ECJ** 

- Features
- Small in size and large capacitance
- Low ESR/ESL and excellent High-frequency characteristics
- Optimal change from TANTALUM CHIP CAPACI-TORS and ALUMINUM ELECTROLYTIC CAPACI-TORS
- Recommended Applications
- Class 2 (Hi-K Type)
  - Power supply circuit decoupling applications
     Power supply circuit of the High-speed LSI
     Smoothing circuit of DC-DC converters

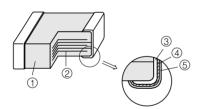
■ Handling Precautions, click here.

■ Packaging Specifications, click here.

#### ■ Explanation of Part Numbers

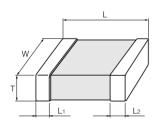


#### ■ Construction



No	Name									
1	Ceramic dielectric									
2	Internal electrode									
3	Terminal	Substrate electrode								
4	electrode	Intermediate electrode								
(5)		External electrode								

#### ■ Dimensions in mm (not to scale)



					Unit : mm	
Code	Size Code (EIA)	L	W	Т	L1, L2	
0	Type"10" (0402)	1.00±0.05	0.50±0.05	0.50±0.05	0.2±0.1	
1	Type"11" (0603)	1.6±0.1	0.8±0.1	0.8±0.1	0.3±0.2	
		2.0±0.1	1.25±0.10	0.85±0.10		
0		2.0±0.1	1.25±0.10	1.25±0.10	0.50.0.05	
2	Type"12" (0805)	2.00±0.15	1.25±0.15	1.25±0.15	0.50±0.25	
		2.0±0.2	1.25±0.20	1.25±0.20		
С		2.0±0.2	1.25±0.20	0.05.0.10	0.50.005	
G		2.00±0.15 1.25±0.15		0.85±0.10	0.50±0.25	
		3.20±0.15	1.60±0.15	0.85±0.10		
3	T "40"	0.2010.10	1.00±0.15	1.15±0.10	0.6±0.3	
	Type"13"	3.2±0.2	1.6±0.2	1.6±0.2		
D	(1206)	0.0.00	10.00	0.85±0.10	0.0.00	
M		3.2±0.2	1.6±0.2	1.15±0.10	0.6±0.3	
4		22.02	2.5±0.2	2.0±0.2	0.0.0.0	
4	Type"23"	3.2±0.3	2.5±0.3	2.5±0.3	0.6±0.3	
9	(1210)		2.5±0.2	0.85±0.10	0.6±0.3	

# ■ Packaging Styles and Standard Packaging Quantity

T: Thickness (mm)

Code	Code Packaging Styles		Quantity	Type"10" (0402)	Type"11" (0603)		e"12" 05)	-	Type"13' (1206)	11	٦	ype"23" (1210)	
			-	T=0.5	T=0.8	T=0.85	T=1.25	T=0.85	T=1.15	T=1.6	T=0.85	T=2.0	T=2.5
Е		Paper taping (Pitch:2mm)		10,000	_	_	_	_		_			_
V	φ180	Paper taping (Pitch:4mm)	pcs./	_	4,000	4,000	_	4,000		_	_		_
F	reel	Embossed taping	reel	_		_	3,000	_	3,000	_	3,000		_
Υ		(Pitch:4mm)	_	_	_	_	_		2,000		2,000	1,000	

## ■ Temperature Characteristics

## Class 2 Capacitors

Code	Tomp Char	Canacitanaa Changa	Measurement	Reference
Code	Temp. Char.	Capacitance Change	Temperature Range	Temperature
D	В	±10 %	−25 to 85 °C	20 °C
В	X7R	±15 %	−55 to 125 °C	25 °C
5	X5R	±15 %	−55 to 85 °C	25 °C
Г	F	+30, -80 %	−25 to 85 °C	20 °C
г	Y5V	+22, -82 %	−30 to 85 °C	25 °C

For applicable "Temperature Characteristics", see the lists of standard products on page 8 to 9.

# ■ Rated Voltage

Code	1H	1E	1C	1A	OJ	0G
Rated Voltage	DC 50 V	DC 25 V	DC 16 V	DC 10 V	DC 6.3 V	DC 4 V

# ■ Nominal Capacitance

Ex.	105	225	106	226	107
Nominal Capacitance	1,000,000 pF	2,200,000 pF	10,000,000 pF	22,000,000 pF	100,000,000 pF
	(1 µF)	(2.2 µF)	(10 µF)	(22 µF)	(100 µF)

# ■ Capacitance Tolerance

Class	Temp. Char.	Tol. Code	Capacitance Tolerance
2	D V7D VED	K	±10 %
	B, X7R, X5R	M	±20 %
	F, Y5V	Z	+80, -20 %

## ■ Specification and Test Method

Item	Specification	Test Method
Operating Temperature Range	Temp. Char. B, X7R: -55 to 125 °C Temp. Char. B, X5R: -55 to 85 °C Temp. Char. F, Y5V: -30 to 85 °C	
Dielectric Withstanding Voltage	No break down	Test voltage: Rated voltage ×250% Duration:1 to 5s. Charge/discharge current:within 50 mA
Insulation Resistance (I R)	500/C (M $\Omega$ ) min. Note:DC10V, DC6.3V;100/C(M $\Omega$ )min. (C:Nominal Cap. in $\mu F$ )	Measuring voltage:Rated voltage Duration:60±5s Charge/discharge current:within 50 mA
Cpacitance	within the specified tolerance	Measuring temperature:20±2°C
Dissipation Factor (tan $\delta$ )	0.2 max. Please confirmation to the technical reports for details.	Pretreatment:The capacitors shall be kept in a temperature of 150+0/-10°C for 1 hour and then shall be stored in standard condition* 48±4 hours, before initial measurement.
		Nominal capacitance C≦10µF C>10µF
		Measuring frequency 1kHz±10% 120Hz±20% Mesuring voltage 1.0±0.2Vrms 0.5±0.2Vrms
Temperature Characteristics	Temp. Char. B: ±10 % (-25 to 85 °C)	Maximum capacitance change at stage 1 to 5
	X7R: ±15 % (-55 to 125 °C) X5R: ±15 % (-55 to 85 °C) F : +30, -80 % (-25 to 85 °C) Y5V: +22, -82 % (-30 to 85 °C)	Temp. Char.         B, F         X7R         X5R         Y5V           Stage 1         20°C         25°C         25°C         25°C           Stage 2         -25°C         -55°C         -55°C         -30°C           Stage 3         20°C         25°C         25°C         25°C           Stage 4         85°C         125°C         85°C         85°C           Stage 5         20°C         25°C         25°C         25°C           *ECJ0EB0J105□(0402/X5R/6.3V1.0µF         *ECJ1VB0J475□(0603/X5R/6.3V/4.7µF)           *ECJ1VB0G106M(0603/X5R/4V/10µF)         *ECJ1VB0G106M(0603/X5R/4V/10µF)
Adhesion	The terminal electrode shall be free from peeling or signs of peeling.	of 0.50±0.05 Vrms measurement voltage Applied force:5N Duration:10s
		Sample Unit: mm
Bending Strength	Appearance:no mechanical damage Capacitance change: Temp. Char. B, X7R, X5R: within ±12.5 % F, Y5V: within ±30 %	Bending value:1 mm Bending speed:1 mm/s  20 R340 Bending value:1 mm R340 Bending value:1 mm R340 Bending value:1 mm
Vibration Proof	Appearance: There shall be no cracks and other mechanical damage. Capacitance:Shall be within the specified tolerance $\tan\delta$ :initial value	Apply a variable vibration of 1.5mm total amplitude in the 10 to 55 to 10Hz vibration frequency range swept in 1 min in 3 mutually perpendicular directions for 2 hours each, a total of 6 hours.
Solderability	More than 95 % of the soldered area of both terminal electrodes shall be covered with fresh solder.	Solder bath method Solder temperature:230±5 °C Dipping period:4±1 s Solder:H63A (JIS-Z-3282)

\*Standard condition : Temperature 15 to 35  $^{\circ}\text{C},$  Relative humidity 45 to 75 %

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/High	١
(High Capacitance	)

Item	Specification	Test Method
Resistance to Solder Heat	Appearance:no mechanical damage Capacitance change: Temp. Char. B, X7R, X5R: within ±7.5 % F, Y5V: within ±20 % tanδ initial value IR:initial value With-stand voltage:no dielectric breakdown or damage	Solder bath method Preconditioning: Heat treatment (150°C, 1h) Solder temperature:270±5°C Dipping period:3.0±0.5 s Preheat condition: Temp. Type"10","11","12" Type"13","23" 80 to 100°C 120 to 180s 300 to 360s 150 to 200°C 120 to 180s 300 to 360s Recovery(Standard condition):48 ± 4h
Temperature Cycle	Appearance:no mechanical damage Capacitance change: Temp. Char. B, X7R, X5R: within ±7.5 % F, Y5V: within ±20 % tanδ initial value IR:initial value With-stand voltage: no dielectric breakdown or damage	Preconditioning: Heat treatment (150°C,1h) Step 1:Minimum operation temp. 30±3 min. Step 2:Room temp. 3 min. Step 3:Maximum operation temp. 30±3 min. Step 4:Room temp. 3 min. Number of cycles:5 cycles Recovery(Standard condition):48 ± 4h
Damp Heat (steady state)	Appearance:no mechanical damage Capacitance change: Temp. Char. B, X7R, X5R: within ±12.5 % F, Y5V: within ±30 % Note:ECJ0EB0J105 (0402/X5R/6.3V/1.0μF) ECJ1VB0J475 (0603/X5R/6.3V/4.7μF) ECJ1VB0G106M(0603/X5R/4V/10μF) within ±20 % tanδ 0.3 max. Please confirmation to the technical reports for details. IR:50/C (MΩ) min. Note:DC10V, DC6.3V;10/C (MΩ)min.(C:Nominal cap. in μF)	Preconditioning: Heat treatment (150°C,1h) Temperature:40±2°C Relative humidity:90 to 95 % Test period:500+24/0 h Recovery(Standard condition):48 ± 4h
Loading Under Damp Heat	Appearance:no mechanical damage Capacitance change: Temp. Char. B, X7R, X5R: within ±12.5 % F, Y5V: within ±30 % Note: ECJ0EB0J105 (0402/X5R/6.3V/1.0μF) ECJ1VB0J475 (0603/X5R/6.3V/4.7μF) ECJ1VB0G106M(0603/X5R/4V/10μF) within ±20 %  tanδ 0.3 max. Please confirmation to the technical reports for details. IR:25/C (MΩ) min. Note:DC10V, DC6.3V;5/C (MΩ)min.(C:Nominal cap. in μF)	Preconditioning: Voltage treatment Temperature:40±2 °C Relative humidity:90 to 95 % Applied voltage:Rated voltage Test period:500+24/0 h Recovery(Standard condition):48 ± 4h
Loading at High Temperature	Appearance:no mechanical damage Capacitance change: Temp. Char. B, X7R, X5R: within $\pm 12.5~\%$ F, Y5V: within $\pm 30~\%$ Note:ECJ0EB0J105 $[(0402/X5R/6.3V/1.0\mu\text{F})]$ ECJ1VB0J475 $[(0603/X5R/6.3V/4.7\mu\text{F})]$ ECJ1VB0G106M(0603/X5R/4V/10 $\mu\text{F})$ within $\pm 20~\%$ tan $\delta$ 0.3 max. Please confirmation to the technical reports for details. IR:50/C (M $\Omega$ ) min. Note:DC10V, DC6.3V;10/C (M $\Omega$ )min.(C:Nominal cap. in $\mu\text{F})$	Preconditioning: Voltage treatment Temperature: Maximum operation temp. ±3 °C Applied voltage:①Rated voltage×200% ②Rated voltage×150% ③Rated voltage×100% Please confirmation to the technical reports for details. Charge/discharge current: within 50mA Test period:1000+48/0 h Recovery(Standard condition):48 ± 4h

Note 1) Heat treatment:1 h of heat treatment at 150+0/-10°C followed by 48±4 h recovery under the standaad condition.

Note 2) Voltage treatment:1 h of voltage treatment under the specified temperature and voltage for testing followed by 48 ±4 h of recovery under the standaad condition.

# ■ Standard Products for Type "10" (EIA "0402"), Taped Version

	Code	В				
Capaci-	Rated Voltage	DC6.				
tance (µF)	Capacitance Tolerance	Part No.	Dim. T (mm)	Ter Ch X5	np. ar. R	
1	±10%(K) or ±20%(M)	ECJ0EB0J105	0			
	Code	F				
Capaci-	Rated Voltage	DC6	DC6.3V			
tance (µF)	Capacitance	Part No.	Dim. T	Ter Ch	np. ar.	
(μι )	Tolerance	Tarrivo.	(mm)	F	Y5V	
1	+80,-20%(Z)	ECJ0EF0J105Z	0.5	0	0	

Packaging style code: "E" for taped version ( $\phi$ 180 reel, taping pitch: 2 mm) .

## ■ Standard Products for Type "11" (EIA "0603"), Taped Version

	Code		В										
Capaci-	Rated Voltage	DC	16V		DC	10V		DC	6.3V		DC	4V	
tance (µF)	Capacitance	Part No.	Dim.	Temp. Char.	Part No.	Dim. T	Temp. Char.	Part No.	Dim. T	Temp. Char.	Part No.	Dim.	Temp. Char.
(μι )	Tolerance		(mm)	X5R	r art ivo.	(mm)	X5R	T art 140.	(mm)	X5R	Tarrivo.	(mm)	X5R
1	1100/ (1/)	ECJ1VB1C105	0.8	0	ECJ1VB1A105	0.8	0	ECJ1VB0J105	0.8	0			
2.2	±10%(K)				ECJ1VB1A225	0.8	0	ECJ1VB0J225	0.8	0			
4.7	or							ECJ1VB0J475	0.8	0			
10	±20%(M)										ECJ1VB0G106M	0.8	0

	Code								F	=							
Capaci-	Rated Voltage	DC2	.5V			DC1	6V			DC1	OV			DC6	.3V		
tance	Capacitance		Dim.		np.		Dim.		np.		Dim.		np.		Dim.	Ten	
(µF)	Tolerance	Part No.	T		ar. Y5V	Part No.	T		ar. Y5V	Part No.	T	_Ch	ar. Y5V	Part No.	T	_Ch	ar. Y5V
	Tolcrance		(mm)	Г	151		(mm)	Г	VC1		(mm)	Г	VC1		(mm)	Г	VCY
1	+80,	ECJ1VF1E105Z	0.8	0	_	ECJ1VF1C105Z	8.0	0	_	ECJ1VF1A105Z	0.8	0	0				
2.2	-20%(Z)									ECJ1VF1A225Z	0.8	0	0	ECJ1VF0J225Z	8.0	0	0

	Code	F		
Capaci-	Rated Voltage	DC2	5V	
tance (µF)	Capacitance	Part No.	Dim.	Temp. Char.
(μF)	Tolerance	ran no.	(mm)	X5S
	+2222%	FCJ1V41F105M	0.8	0

☐:Capacitance tolerance code: "☐" for "K" or "M"
Packaging style code: "V" for taped version (ø180 reel, taping pitch: 4 mm) .

# ■ Standard Products for Type "12" (EIA "0805"), Taped Version

	Code							E	3								
Capaci-	Rated Voltage	DC:	25V		DC.	16V		DC	10V			DC6	3.3V		DC4V		
tance (µF)	Capacitance Tolerance	Part No.	Dim. T (mm)	Temp. Char. X5R	Part No.	Dim. T (mm)	Temp. Char. X5R	Part No.	Dim. T (mm)	Ter Ch B	ar.	Part No.	Dim. T (mm)	Temp. Char. X5R	Part No.	Dim. T (mm)	Temp. Char. X5R
1		ECJ2FB1E105	1.25	0	ECJ2FB1C105 *	1.25	0	ECJ2FB1A105	1.25	0	0						
2.2	±10%(K)	ECJ2FB1E225  *	1.25	0	ECJ2FB1C225  *	1.25	0	ECJ2FB1A225 = *	1.25	_	0	ECJ2FB0J225K	1.25	0			
4.7	or	ECJ2FB1E475M*	1.25	0	ECJ2FB1C475  *	1.25	0	ECJ2FB1A475 *	1.25	_	0	ECJ2FB0J475M	1.25	0			
10	±20%(M)							ECJ2FB1A106	1.25	_	0	ECJ2FB0J106M	1.25	0			
22															Under development	1.25	0

	Code																
Capaci-	Rated Voltage	DC5	OV			DC2	25V			DC1	6V			DC10V			
tance (µF)	Capacitance	Part No.	Dim. T		np. ar.	Part No.	Dim. T	Ter Ch	np. ar.	Part No.	Dim. T	Ter Ch	np. ar.	Part No.	Dim.	Ter Ch	np. ar.
(μι )	Tolerance	ran No.	(mm)	F	Y5V	r art ivo.	(mm)	F	Y5V	r art ivo.	(mm)	F	Y5V	r art ivo.	(mm)	F	Y5V
1		ECJ2FF1H105Z*	1.25	0	_	ECJ2FF1E105Z*	1.25	0	_	ECJ2VF1C105Z	0.85	0	0				
2.2	+80,					ECJ2FF1E225Z*	1.25	0	_	ECJGVF1C225Z	0.85	0	0				
4.7	-20%(Z)									ECJGVF1C475Z	0.85	0	0	ECJGVF1A475Z	0.85	0	0
10														ECJ2FF1A106Z*	1.25	Ó	0

	Code	Е	3			
Capaci-	Rated Voltage	DC6	3.3V			
tance	Capacitance	Part No.	Dim.	Temp. Char.		
(μι )	Tolerance	rait NO.	(mm)	X5R		
2.2	00	ECJCV50J225M	0.85	0		
4.7	+80,	ECJCV50J475M	0.85	0		
10	-20%(Z)	ECJCV50J106M	0.85	0		

 $\square$ :Capacitance tolerance code : " $\square$ " for "K" or "M" Packaging style code: "V" or "F" for taped version ( $\phi$ 180 reel, taping pitch: 4 mm) . \*:"L", "W", "T" Dimension tolerance  $\pm$ 0.15mm

Soldering method of dimension T>1mm: Do not use the flow soldering.

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## ■ Standard Products for Type "13" (EIA "1206"), Taped Version

	Code											В						
Capaci-	Rated Voltage	DC	25V	/			DC	16V	1			DC1			DC6.3V			
tance (µF)	Capacitance	Part No.	Dim. T		emp. Char.		Part No.	Dim. T		emp Char		Part No.	Dim. T	Temp. Char.		Part No.	Dim. T	Temp. Char.
(pi )	Tolerance	T dit ivo.	(mm)	В	X7R	X5R	T dit 110.	(mm)	В	X7R	X5R	Tantino.	(mm)	В	X5R	rait ivo.	(mm)	X5R
1		ECJ3YB1E105	1.6	0	0	_	ECJ3FB1C105	1.15	0	0	_							
2.2	1400//1/)	ECJ3YB1E225	1.6	_	_	0	ECJ3YB1C225	1.6	0	0	_	ECJ3YB1A225	1.6	0	0			-
2.2 4.7	±10%(K)	ECJ3YB1E475	1.6	_	_	0	ECJ3YB1C475	1.6	_	_	0	ECJ3YB1A475	1.6	_	0	ECJ3YB0J475	1.6	0
10	or or	ECJ3YB1E106	1.6	_	_	0	ECJ3YB1C106	1.6	_	_	0	ECJ3YB1A106M	1.6	_	0	ECJ3YB0J106M	1.6	0
22	±20%(M)	Under development	1.6	_	— O Ur		Under development	1.6	_	_	0	Under development	1.6	_	0	ECJ3YB0J226M	1.6	0
47																Under development	1.6	0

		Code	В									
С	apaci-	Rated Voltage	DC6	3.3V								
	ance (µF)	Capacitance	Part No.	Dim. T	Temp. Char.							
(μι )		Tolerance	1 411 1101	(mm)	X5R							
	10	±10%(K)	ECJDV50J106M	0.85	0							
	22	±20%(M)	ECJDV50J226M	0.85	0							

	Code							F								
Capaci-	Rated Voltage	DC5	OV		DC2	5V			DC1	6V			DC10V			
tance (µF)	Capacitance	Part No.			Part No.	Dim. T	Ter Ch	np. ar.	Part No.	Dim. T	Ter Ch	np. ar.	Part No.	Dim. T	Ten Ch	
(MI)	Tolerance	r art ivo.	(mm)	F	r art ivo.	(mm)	F	Y5V	r art rvo.	(mm)	F	Y5V	r art ivo.	(mm)	F	Y5V
1		ECJ3FF1H105Z	1.15	0	ECJ3FF1E105Z	1.15	0	0	ECJ3VF1C105Z	0.85	0	0				
2.2 4.7 10 22	+80.				ECJ3FF1E225Z	1.15	0	0	ECJ3VF1C225Z	0.85	0	0				
4.7	-20%(Z)				ECJ3FF1E475Z	1.15	0	_	ECJ3FF1C475Z	1.15	0	0				
10	2070(2)				ECJ3YF1E106Z	1.60	0	_	ECJMFF1C106Z	1.15	0	_	ECJMFF1A106Z	1.15	0	0
22													ECJMFF1A226Z	1.15	0	0

 $\square$ :Capacitance tolerance code. : " $\square$ " for "K" or "M" Packaging style code: "F" and "Y" for taped version ( $\phi$ 180 reel, taping pitch: 4 mm) . Soldering method of dimension T>1mm: Do not use the flow soldering.

# ■ Standard Products for Type "23" (EIA "1210"), Taped Version

				71	`														
	Code								E	3									
Capaci-	Rated Voltage	DC:	50V		DC:	25V			DC.	16V		DC.	10V			DC6	5.3V		
tance (µF)	Capacitance Tolerance	Part No.	Dim. T (mm)	Temp. Char. X5R	Part No.	Dim. T (mm)	Ch	np. <u>ar.</u> 5R	Part No.	Dim. T (mm)	Temp. Char. X5R	Part No.	Dim. T (mm)	Ten Ch X5	ar.	Part No.	Dim. T (mm)	Ten Cha X5	<u>ar.                                    </u>
1		ECJ4YB1H105	2.0	0															
2.2					ECJ4YB1E225	2.0		)											
2.2 4.7 10	±10%(K)				ECJ4YB1E475	2.0		)	ECJ4YB1C475	2.0	0								
10	or				ECJ4YB1E106M	2.5		)	ECJ4YB1C106M	2.0	0	ECJ4YB1A106	2.0		)				
22 47	±20%(M)				ECJ4YB1E226M	2.5		)	ECJ4YB1C226M	2.5	0	ECJ4YB1A226M	2.5		)	ECJ4YB0J226M	2.5	С	)
47									ECJ4YB1C476M	2.5	0	ECJ4YB1A476M	2.5		)	ECJ4YB0J476M	2.5	С	)
100																ECJ4YB0J107M	2.5	С	)
	Code								F	_									_
Capaci-	Rated Voltage	DC:	50\/		DC	25\/			DC			DC.	10\/			DC6	3.31/		—
tance			Dim.	Temp.		Dim.	Ter	np.		Dim.	Temp.		Dim.	Ten	np.		Dim.	Ten	
(μF)	Capacitance	Part No.	T	Char.	Part No.	T		ar.	Part No.	T .	Char.	Part No.	T .	Ch	ar.	Part No.	T	Ch	
., .	Tolerance	r art ivo.	(mm)	F	T dit 110.	(mm)	F	Y5V	T art 110.	(mm)	F	T dit 110.	(mm)	F	Y5V	T dit 110.	(mm)	F	Y5V
4.7		ECJ4YF1H475Z	2.0	0	ECJ4YF1E475Z	2.0	0	0											
10	. 00	ECJ4YF1H106Z	2.0	0	ECJ4YF1E106Z	2.0	0	0	ECJ4YF1C106Z	2.0	0								
22	+80,				ECJ4YF1E226Z	2.0	0	0	ECJ4YF1C226Z	2.0	0	ECJ9FF1A226Z	0.85	0	0				_
4.7 10 22 47	-20%(Z)											ECJ4YF1A476Z	2.0	0	0	ECJ4YF0J476Z	2.0	0	0
100																ECJ4YF0J107Z	2.5	0	0

:Capacitance tolerance code.: "[]" for "K" or "M"
Packaging style code: "Y" for taped version (\( \phi 180 \) reel, taping pitch: 4 mm) .

Soldering method of dimension T>1mm: Do not use the flow soldering.

■ Standard Products for Type "34" (EIA "1812") will be discontinued. The schedule will be announced.

October 2005